

1. Features

- Typical 1dB bandwidth of 9.2 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

2. Electrical Specifications

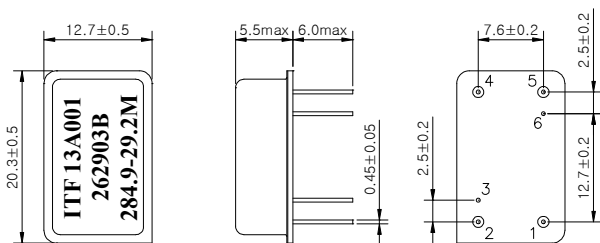
Source and Load Impedance = 50Ω

Operating Temperature : -10°C ~ +60°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	284.9	-
Insertion Loss	dB	-	31.0	33.0
1dB Bandwidth	MHz	29.10	29.25	-
3dB Bandwidth	MHz	-	29.53	-
40dB Bandwidth	MHz	-	30.77	30.95
Amplitude Ripple (fo ± 14.22 MHz)	dB	-	0.60	1.2
Group Delay Variation (fo ± 14.22 MHz)	nsec	-	50	100
Absolute Delay	usec	-	2.86	-
Ultimate Rejection	dB	50	53	-
Out of Band Gain Edge ± 1.16MHz		20	30	-
Maximum input Power	dBm	-	-	10
Temperature Coefficient of Frequency	ppm/°C	-	-18	-

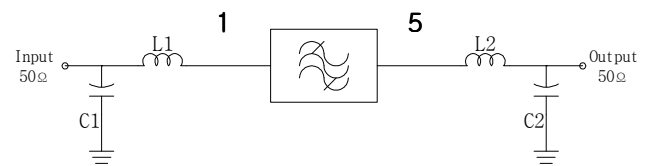
Edge : $F_c \pm 14.22 \text{MHz}$

Room Temperature : +25°C		Minimum	Typical	Maximum
Insertion Loss	dB	-	31.0	33.0
Amplitude Ripple (fo ± 14.40 MHz)	dB	-	0.60	1.2
Group Delay Variation (fo ± 14.40 MHz)	nsec	-	50	100

D2012 Package Dimension



Matching Schematic



$L1 = L2 = 10\text{nH}, C1 = C2 = 33\text{pF}$

Pin Configuration

	1	Ground	2,4
Input	1	Ground	2,4
Output	5	Others	Ground

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
 Cap : Cu & Cr Alloy, Ni Plated
 Termination : Kovar, Au Plated

3. Typical Performance (at +25°C)

